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(54) POLYURETHANE RESIN COMPOSITION

(57)Abstract:

PURPOSE: To obtain a heat-resistant composition curable at normal temperature without necessity of baking in air by dissolving or dispersing a polyurethane resin, polycarbosilane, silicone resin and inorganic filler in organic solvent.

CONSTITUTION: A polyurethane resin, polycarbosilane and/or silicone resin and inorganic filler are dissolved or dispersed in an organic solvent. A silicone oil, silicone vanish or silicone rubber, etc., is used as a silicone resin. 20-50 pts.wt. total components except polyurethane resin is preferably used to 100 pts.wt. polyurethane resin. A polycarbosilane only or mixture of polycarbosilane and silicone resin is preferably used to improve heat resistance.

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